

FQD12N20LTM-F085 Datasheet



 DiGi Electronics Part Number
 FQD12N20LTM-F085-DG

 Manufacturer
 onsemi

 Manufacturer Product Number
 FQD12N20LTM-F085

 Description
 MOSFET N-CH 200V 9A DPAK

 Detailed Description
 N-Channel 200 V 9A (Tc) 2.5W (Ta), 55W (Tc) Surfac e Mount TO-252AA

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FQD12N20LTM-F085	onsemi
Series:	Product Status:
QFET [®]	Not For New Designs
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (ld) @ 25°C:
200 V	9А (Тс)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
5V, 10V	280mOhm @ 4.5A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
2V @ 250μΑ	21 nC @ 5 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	1080 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	2.5W (Ta), 55W (Tc)
Operating Temperature:	Grade:
-55°C ~ 150°C (TJ)	Automotive
Qualification:	Mounting Type:
AEC-Q101	Surface Mount
Supplier Device Package:	Package / Case:
TO-252AA	TO-252-3, DPAK (2 Leads + Tab), SC-63
Base Product Number:	
FQD12N20	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	

onsemi

MOSFET – N-Channel, QFET

200 V, 9.0 A, 280 m Ω

FQD12N20L

Description

This N-Channel enhancement mode power MOSFET is produced using **onsemi**'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 9.0 A, 200 V, $R_{DS(on)}$ = 280 m Ω (Max.) @ V_{GS} = 10 V, I_D = 4.5 A
- Low Gate Charge (Typ. 16 nC)
- Low Crss (Typ. 17 pF)
- 100% Avalanche Tested

Parameter		Rating	Unit
Drain-Source Voltage		200	V
Drain Current	– Continuous (T _C = 25°C)	9.0	А
	– Continuous (T _C = 100°C)	5.7	А
Drain Current	 Pulsed (Note 1) 	36	А
Gate-Source \	/oltage	±20	V
Single Pulsed Avalanche Energy (Note 2)		210	mJ
Avalanche Current (Note 1)		9.0	А
Repetitive Avalanche Energy (Note 1)		5.5	mJ
Peak Diode Recovery dv/dt (Note 3)		5.5	V/ns
Power Dissipat	tion (T _A = 25°C) *	2.5	W
Power Dissipat	Power Dissipation (T _C = 25° C)		W
– Derate Above 25°C		0.44	W/°C
Operating and Storage Temperature Range		–55 to +150	°C
Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C
	Drain Current Drain Current Gate–Source V Single Pulsed A Avalanche Cur Repetitive Aval Peak Diode Re Power Dissipat Power Dissipat Operating and Maximum Lead	$\begin{array}{ c c c c c } \hline & & & & & \\ \hline & & & & \\ \hline & & & & \\ \hline & & \hline \\ \hline & & \\ \hline \hline & & \\ \hline \hline & & \\ \hline \hline \\ \hline & & \\ \hline \hline \\ \hline & & \\ \hline \hline \hline \\ \hline \hline \hline \\ \hline \hline \hline \\ \hline \hline \hline \hline \\ \hline \hline \hline \hline \hline \hline \\ \hline \hline \hline \hline \hline \hline \hline \\ \hline \hline$	$\begin{tabular}{ c c c } \hline Prime Point P$

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter	Rating	Unit
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	2.27	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	50	

V _{DSS}	R _{DS(on)} MAX	I _D MAX
200 V	280 mΩ @ 10 V	9.0 A



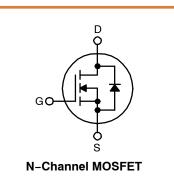
MARKING DIAGRAM



&Z = Assembly Plant Code

&3= 3-Digit Date Code&K= 2-Digits Lot Run Traceability Code

FQD12N20L = Device Code



ORDERING INFORMATION

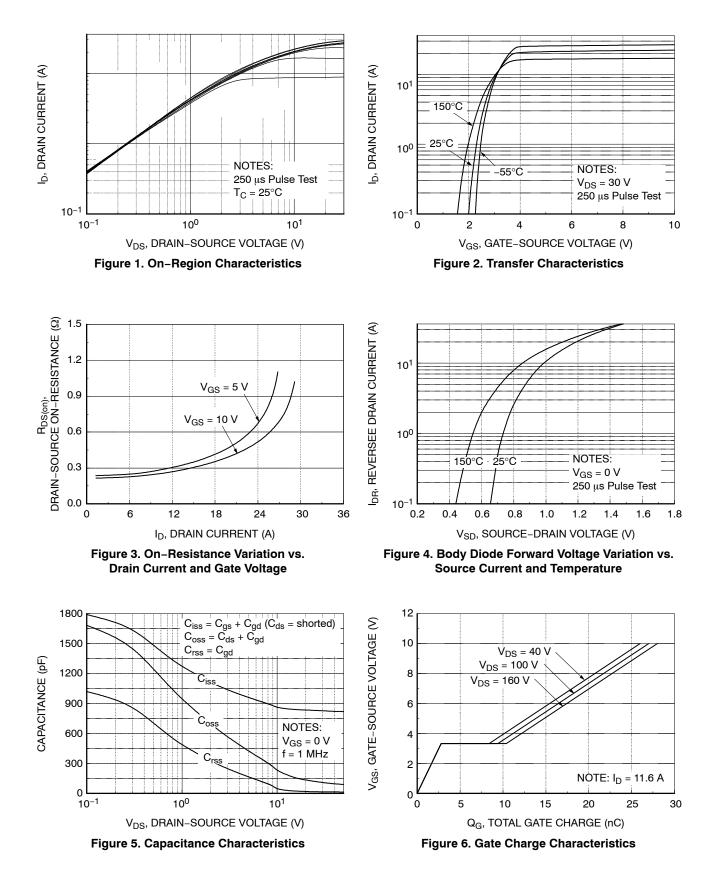
See detailed ordering and shipping information on page 6 of this data sheet.

ELECTRICAL CHARACTERISTICS	$(T_{C} = 25^{\circ}C \text{ unless otherwise noted})$

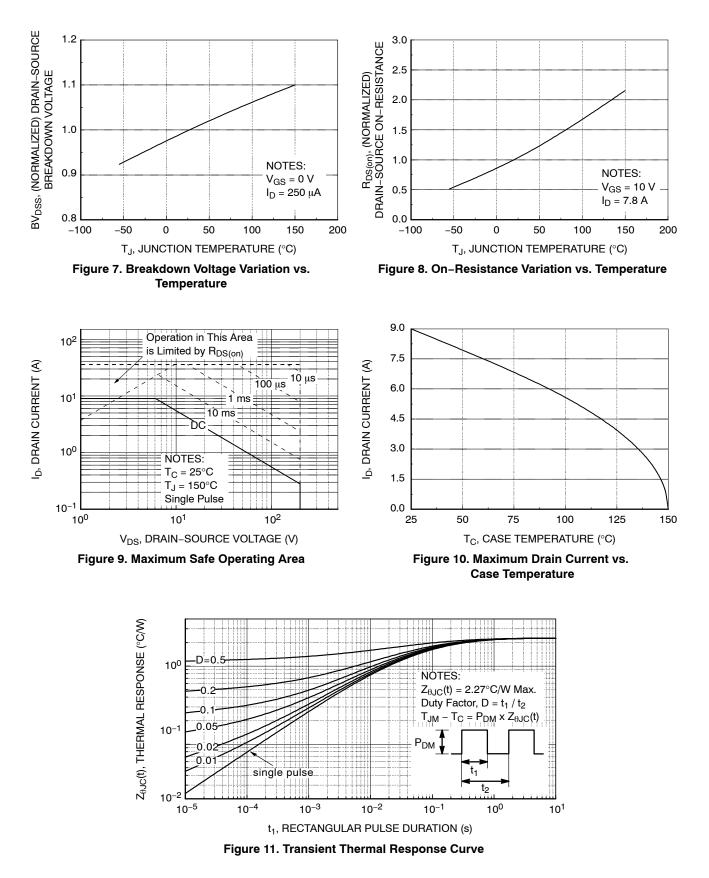
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OFF CHAR	ACTERISTICS	•				
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	200	-	-	V
$\frac{\Delta \text{BV}_{\text{DSS}}}{\Delta \text{T}_{\text{J}}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	_	0.14	-	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA
		$V_{DS} = 160 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	-	10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	-100	nA
ON CHARA	CTERISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	1.0	-	2.0	V
R _{DS(on)}	Static Drain-Source On-Resistance			0.22 0.25	0.28 0.32	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 30 V, I _D = 4.5 A	-	11.6	-	S
DYNAMIC C	CHARACTERISTICS					
C _{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	-	830	1080	pF
C _{oss}	Output Capacitance		-	120	155	pF
C _{rss}	Reverse Transfer Capacitance		-	17	22	pF
SWITCHING	G CHARACTERISTICS					
t _{d(on)}	Turn-On Delay Time	V_{DD} = 100 V, I _D = 11.6 A, R _G = 25 Ω (Note 4)	-	15	40	ns
t _r	Turn-On Rise Time		-	190	390	ns
t _{d(off)}	Turn-Off Delay Time		-	60	130	ns
t _f	Turn-Off Fall Time		-	120	250	ns
Qg	Total Gate Charge	$V_{DS} = 160 \text{ V}, \text{ I}_{D} = 11.6 \text{ A},$	-	16	21	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V (Note 4)	-	2.8	-	nC
Q _{gd}	Gate-Drain Charge	1		7.6	-	nC
DRAIN-SO	URCE DIODE CHARACTERISTICS AND MAXI	MUM RATINGS		-	-	
۱ _S	I _S Maximum Continuous Drain-Source Diode Forward Current		_	-	9.0	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		-	-	36	Α
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, \text{ I}_{S} = 9.0 \text{ A}$	-	-	1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 11.6 A,$	-	128	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs	-	0.56	-	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. L = 3.9 mH, I_{AS} = 9.0 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C. 3. I_{SD} ≤ 11.6 A, di/dt ≤ 300 A/µs, V_{DD} ≤ BV_{DSS}, starting T_J = 25°C. 4. Essentially independent of operating temperature.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)



FQD12N20L

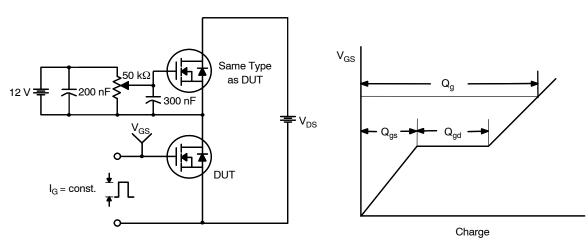


Figure 12. Gate Charge Test Circuit & Waveform

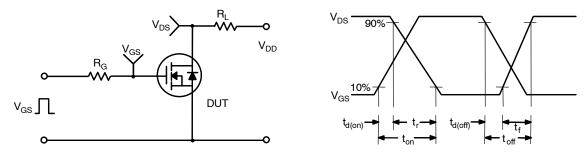


Figure 13. Resistive Switching Test Circuit & Waveforms

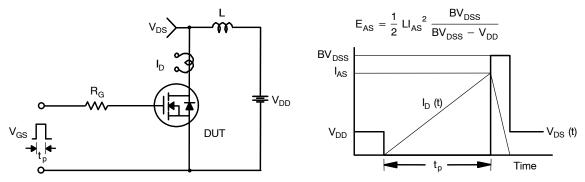
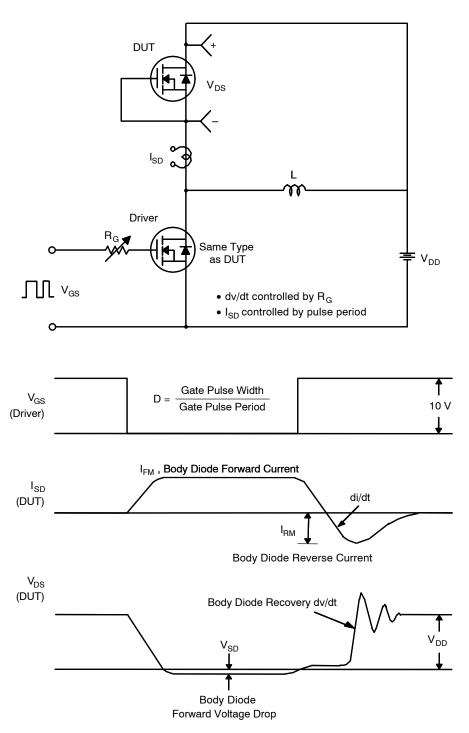
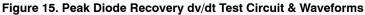


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





PACKAGE MARKING AND ORDERING INFORMATION

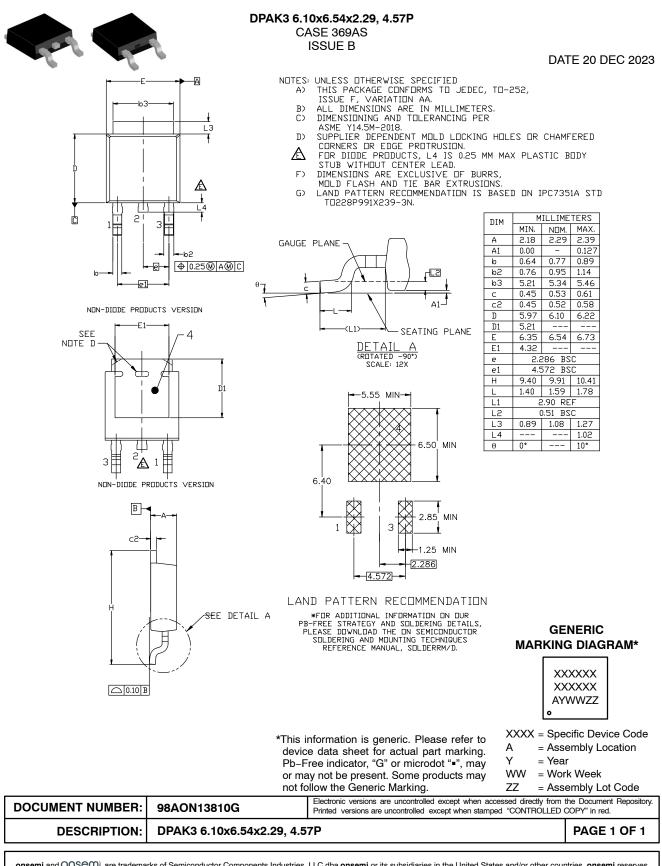
Device	Device Marking	Package	Shipping [†]
FQD12N20LTM	FQD12N20L	DPAK3 (TO-252 3 LD)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



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